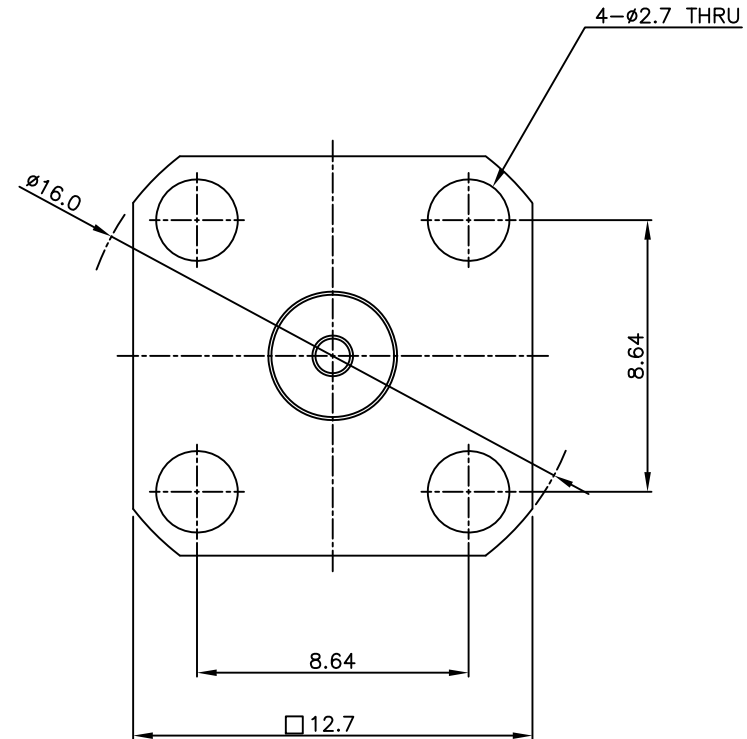
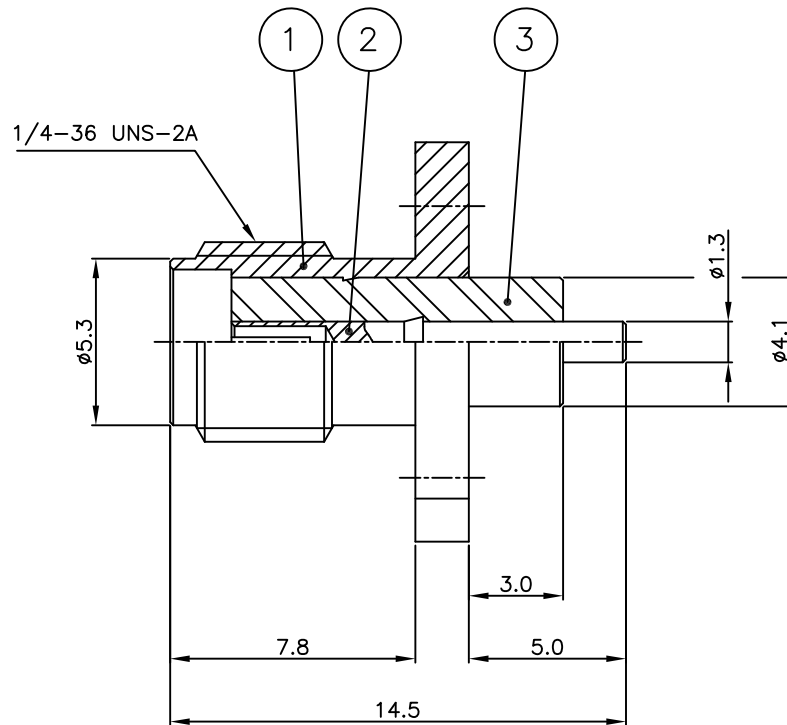


REVISION		
REV	DESCRIPTION	DATE
IR	Initial Registration	2009. 12. 01.
1	[설변No.201003-0032] 업체요청-BODY 도금SPEC 변경	2010. 03. 26.
2	[설변No.201204-0012] BODY 내부 닦시바늘 추가	2012. 04. 26.



2	3	INSULATOR	1	TEFLON		DIN00190-N/1 DIN00125-N/1
	2	CONTACT	1	Beryllium copper	Gold Plated	DCT02173-5/1
2 1	1	BODY	1	BRASS	Nickel Plated Gold Plated	DBD00363-5/2 DBD00363-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2010. 04. 26.		KJ  COMTECH KJ COMTECH CO.,LTD.	RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	J.H.YOUN		
MATERIAL	±1°	CHECKED BY		TITLE	SMA50 SOLDER END JS-4H
	_____	DRAWN BY	I.C.KIM		
FINISH	_____	SCALE	UNIT	A4	DWG NO. CN02509-7/2
		3/1	mm 		